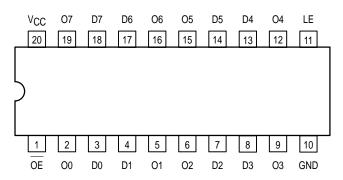
# Low-Voltage CMOS Octal Transparent Latch With 5V-Tolerant Inputs and Outputs (3-State, Non-Inverting)

The MC74LCX373 is a high performance, non–inverting octal transparent latch operating from a 2.7 to 3.6V supply. High impedance TTL compatible inputs significantly reduce current loading to input drivers while TTL compatible outputs offer improved switching noise performance. A V $_{\parallel}$  specification of 5.5V allows MC74LCX373 inputs to be safely driven from 5V devices.

The MC74LCX373 contains 8 D-type latches with 3-state outputs. When the Latch Enable (LE) input is HIGH, data on the Dn inputs enters the latches. In this condition, the latches are transparent, i.e., a latch output will change state each time its D input changes. When LE is LOW, the latches store the information that was present on the D inputs a setup time preceding the HIGH-to-LOW transition of LE. The 3-state standard outputs are controlled by the Output Enable (OE) input. When OE is LOW, the standard outputs are enabled. When OE is HIGH, the standard outputs are in the high impedance state, but this does not interfere with new data entering into the latches.

- Designed for 2.7 to 3.6V VCC Operation
- 5V Tolerant Interface Capability With 5V TTL Logic
- · Supports Live Insertion and Withdrawal
- IOFF Specification Guarantees High Impedance When VCC = 0V
- LVTTL Compatible
- LVCMOS Compatible
- 24mA Balanced Output Sink and Source Capability
- Near Zero Static Supply Current in All Three Logic States (10μA) Substantially Reduces System Power Requirements
- Latchup Performance Exceeds 500mA
- ESD Performance: Human Body Model >2000V; Machine Model >200V

# Pinout: 20-Lead (Top View)



# **MC74LCX373**



LOW-VOLTAGE CMOS OCTAL TRANSPARENT LATCH



**DW SUFFIX**PLASTIC SOIC
CASE 751D-04



M SUFFIX PLASTIC SOIC EIAJ CASE 967-01



SD SUFFIX PLASTIC SSOP CASE 940C-03



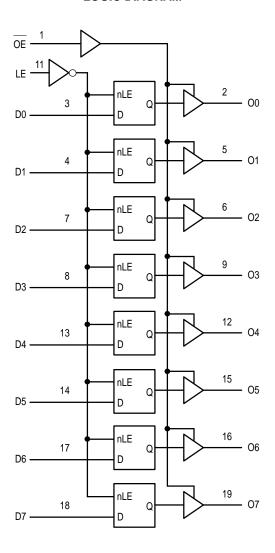
DT SUFFIX PLASTIC TSSOP CASE 948E-02

#### **PIN NAMES**

Pins	Function
OE LE D0-D7 O0-O7	Output Enable Input Latch Enable Input Data Inputs 3-State Latch Outputs



# **LOGIC DIAGRAM**



	INPUTS		OUTPUTS			
OE	LE	Dn	On	OPERATING MODE		
L L	H H	H L	H L	Transparent (Latch Disabled); Read Latch		
L L	L L	h I	H L	Latched (Latch Enabled) Read Latch		
L	L	Х	NC	Hold; Read Latch		
Н	L	Х	Z	Hold; Disabled Outputs		
H H	H H	Ι⊔	Z Z	Transparent (Latch Disabled); Disabled Outputs		
H H	L L	h I	Z Z	Latched (Latch Enabled); Disabled Outputs		

H = High Voltage Level; h = High Voltage Level One Setup Time Prior to the Latch Enable High-to-Low Transition; L = Low Voltage Level; I = Low Voltage Level One Setup Time Prior to the Latch Enable High-to-Low Transition; NC = No Change, State Prior to the Latch Enable High-to-Low Transition; X = High or Low Voltage Level or Transitions are Acceptable; Z = High Impedance State; For ICC Reasons DO NOT FLOAT Inputs

### **ABSOLUTE MAXIMUM RATINGS\***

Symbol	Parameter	Value	Condition	Unit
Vcc	DC Supply Voltage	−0.5 to +7.0		V
VI	DC Input Voltage	$-0.5 \le V_1 \le +7.0$		V
Vo	DC Output Voltage	$-0.5 \le V_{O} \le +7.0$	Output in 3–State	V
		$-0.5 \le V_{O} \le V_{CC} + 0.5$	Note 1.	V
ΙιΚ	DC Input Diode Current	-50	V <sub>I</sub> < GND	mA
loк	DC Output Diode Current	-50	V <sub>O</sub> < GND	mA
		+50	AO > ACC	mA
Io	DC Output Source/Sink Current	±50		mA
Icc	DC Supply Current Per Supply Pin	±100		mA
IGND	DC Ground Current Per Ground Pin	±100		mA
T <sub>STG</sub>	Storage Temperature Range	-65 to +150		°C

<sup>\*</sup> Absolute maximum continuous ratings are those values beyond which damage to the device may occur. Exposure to these conditions or conditions beyond those indicated may adversely affect device reliability. Functional operation under absolute–maximum–rated conditions is not implied.

1. Output in HIGH or LOW State. I<sub>O</sub> absolute maximum rating must be observed.

# **RECOMMENDED OPERATING CONDITIONS**

Symbol	Parameter	Min	Тур	Max	Unit
Vcc	Supply Voltage Operating Data Retention Only	2.0 1.5	3.3 3.3	3.6 3.6	V
VI	Input Voltage	0		5.5	V
Vo	Output Voltage (HIGH or LOW State) (3–State)	0 0		VCC 5.5	V
IOH	HIGH Level Output Current, V <sub>CC</sub> = 3.0V – 3.6V			-24	mA
lol	LOW Level Output Current, V <sub>CC</sub> = 3.0V – 3.6V			24	mA
<sup>I</sup> ОН	HIGH Level Output Current, V <sub>CC</sub> = 2.7V – 3.0V			-12	mA
lol	LOW Level Output Current, V <sub>CC</sub> = 2.7V – 3.0V			12	mA
TA	Operating Free–Air Temperature	-40		+85	°C
Δt/ΔV	Input Transition Rise or Fall Rate, $V_{IN}$ from 0.8V to 2.0V, $V_{CC} = 3.0V$	0		10	ns/V

# DC ELECTRICAL CHARACTERISTICS

			T <sub>A</sub> = -40°C	T <sub>A</sub> = -40°C to +85°C	
Symbol	Characteristic	Condition	Min	Max	Unit
V <sub>IH</sub>	HIGH Level Input Voltage (Note 2.)	2.7V ≤ V <sub>CC</sub> ≤ 3.6V	2.0		V
V <sub>IL</sub>	LOW Level Input Voltage (Note 2.)	2.7V ≤ V <sub>CC</sub> ≤ 3.6V		0.8	V
Vон	HIGH Level Output Voltage	$2.7V \le V_{CC} \le 3.6V$ ; $I_{OH} = -100\mu A$	V <sub>CC</sub> - 0.2		V
		$V_{CC} = 2.7V; I_{OH} = -12mA$	2.2		
		$V_{CC} = 3.0V; I_{OH} = -18mA$	2.4		
		$V_{CC} = 3.0V; I_{OH} = -24mA$	2.2		
VOL	LOW Level Output Voltage	$2.7V \le V_{CC} \le 3.6V; I_{OL} = 100\mu A$		0.2	V
		V <sub>CC</sub> = 2.7V; I <sub>OL</sub> = 12mA		0.4	
		V <sub>CC</sub> = 3.0V; I <sub>OL</sub> = 16mA		0.4	
		V <sub>CC</sub> = 3.0V; I <sub>OL</sub> = 24mA		0.55	

<sup>2.</sup> These values of  $V_{\parallel}$  are used to test DC electrical characteristics only.

# DC ELECTRICAL CHARACTERISTICS (continued)

			T <sub>A</sub> = -40°C to +85°C		
Symbol	Characteristic	Condition	Min	Max	Unit
Ц	Input Leakage Current	$2.7V \le V_{CC} \le 3.6V; \ 0V \le V_{I} \le 5.5V$		±5.0	μΑ
loz	3–State Output Current	$2.7 \le V_{CC} \le 3.6V$ ; $0V \le V_O \le 5.5V$ ; $V_I = V_{IH}$ or $V_{IL}$		±5.0	μΑ
lOFF	Power-Off Leakage Current	$V_{CC} = 0V$ ; $V_I$ or $V_O = 5.5V$		10	μΑ
ICC	Quiescent Supply Current	$2.7 \le V_{CC} \le 3.6V$ ; $V_I = GND$ or $V_{CC}$		10	μΑ
		$2.7 \le V_{CC} \le 3.6V$ ; $3.6 \le V_I$ or $V_O \le 5.5V$		±10	μΑ
ΔlCC	Increase in I <sub>CC</sub> per Input	$2.7 \le V_{CC} \le 3.6V; V_{IH} = V_{CC} - 0.6V$		500	μΑ

# AC CHARACTERISTICS ( $t_R = t_F = 2.5 ns; C_L = 50 pF; R_L = 500 \Omega$ )

		Limits					
				T <sub>A</sub> = -40°C to +85°C			1
			V <sub>CC</sub> = 3.	0V to 3.6V	V <sub>CC</sub> :	= 2.7V	1
Symbol	Parameter	Waveform	Min	Max	Min	Max	Unit
tPLH tPHL	Propagation Delay D <sub>n</sub> to O <sub>n</sub>	1	1.5 1.5	8.0 8.0	1.5 1.5	9.0 9.0	ns
tPLH tPHL	Propagation Delay LE to O <sub>n</sub>	3	1.5 1.5	8.5 8.5	1.5 1.5	9.5 9.5	ns
<sup>t</sup> PZH <sup>t</sup> PZL	Output Enable Time to HIGH and LOW Level	2	1.5 1.5	8.5 8.5	1.5 1.5	9.5 9.5	ns
<sup>t</sup> PHZ <sup>t</sup> PLZ	Output Disable Time from HIGH and LOW Level	2	1.5 1.5	7.5 7.5	1.5 1.5	8.5 8.5	ns
t <sub>S</sub>	Setup Time, HIGH or LOW Dn to LE	3	2.5		2.5		ns
th	Hold Time, HIGH or LOW D <sub>n</sub> to LE	3	1.5		1.5		ns
t <sub>W</sub>	LE Pulse Width, HIGH	3	3.3		3.3		ns
tOSHL tOSLH	Output-to-Output Skew (Note 3.)			1.0 1.0			ns

<sup>3.</sup> Skew is defined as the absolute value of the difference between the actual propagation delay for any two separate outputs of the same device. The specification applies to any outputs switching in the same direction, either HIGH-to-LOW (toshl) or Low-to-HIGH (tosl); parameter guaranteed by design.

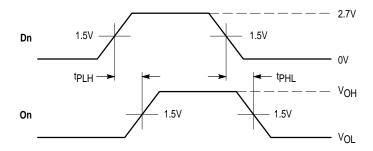
# **DYNAMIC SWITCHING CHARACTERISTICS**

			T <sub>A</sub> = +25°C			
Symbol	Characteristic	Condition	Min	Тур	Max	Unit
VOLP	Dynamic LOW Peak Voltage (Note 4.)	$V_{CC} = 3.3V$ , $C_L = 50pF$ , $V_{IH} = 3.3V$ , $V_{IL} = 0V$		0.8		V
V <sub>OLV</sub>	Dynamic LOW Valley Voltage (Note 4.)	$V_{CC} = 3.3V$ , $C_L = 50pF$ , $V_{IH} = 3.3V$ , $V_{IL} = 0V$		0.8		V

<sup>4.</sup> Number of outputs defined as "n". Measured with "n-1" outputs switching from HIGH-to-LOW or LOW-to-HIGH. The remaining output is measured in the LOW state.

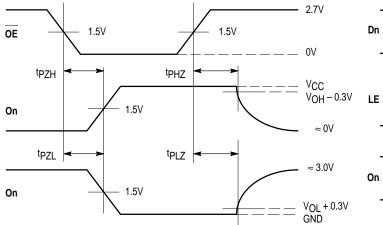
# **CAPACITIVE CHARACTERISTICS**

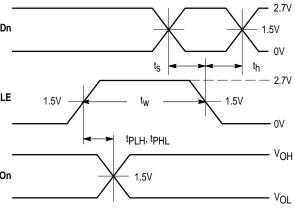
Symbol	Parameter	Parameter Condition		Unit
C <sub>IN</sub>	Input Capacitance	$V_{CC} = 3.3V$ , $V_I = 0V$ or $V_{CC}$	7	pF
COUT	Output Capacitance	$V_{CC} = 3.3V$ , $V_I = 0V$ or $V_{CC}$	8	pF
C <sub>PD</sub>	Power Dissipation Capacitance	10MHz, $V_{CC} = 3.3V$ , $V_I = 0V$ or $V_{CC}$	25	pF



# WAVEFORM 1 - PROPAGATION DELAYS

 $t_R = t_F = 2.5 \text{ns}, 10\% \text{ to } 90\%; f = 1 \text{MHz}; t_W = 500 \text{ns}$ 





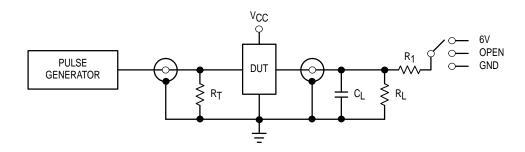
# WAVEFORM 2 - OUTPUT ENABLE AND DISABLE TIMES

 $t_R = t_F = 2.5$ ns, 10% to 90%; f = 1MHz;  $t_W = 500$ ns

#### WAVEFORM 3 - LE to On PROPAGATION DELAYS, LE MINIMUM PULSE WIDTH, Dn to LE SETUP AND HOLD TIMES

 $t_R = t_F = 2.5$ ns, 10% to 90%; f = 1MHz;  $t_W = 500$ ns except when noted

Figure 1. AC Waveforms



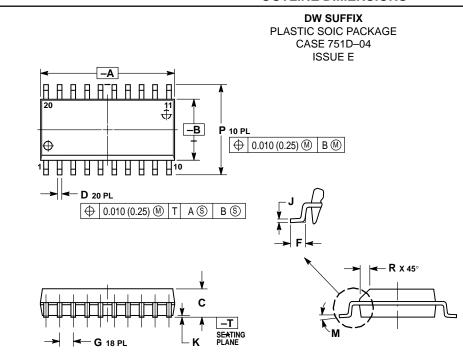
TEST	SWITCH
tPLH, tPHL	Open
tPZL, tPLZ	6V
Open Collector/Drain tpLH and tpHL	6V
<sup>t</sup> PZH <sup>, t</sup> PHZ	GND

 $C_L$  = 50pF or equivalent (Includes jig and probe capacitance)  $R_L$  =  $R_1$  = 500 $\Omega$  or equivalent  $R_T$  =  $Z_{OUT}$  of pulse generator (typically 50 $\Omega$ )

Figure 2. Test Circuit

5

### **OUTLINE DIMENSIONS**



- NOTES:
  1. DIMENSIONING AND TOLERANCING PER
  - ANSI Y14.5M, 1982.
    2. CONTROLLING DIMENSION: MILLIMETER.
- DIMENSIONS A AND B DO NOT INCLUDE MOLD PROTRUSION.
   MAXIMUM MOLD PROTRUSION 0.150 (0.006) PER SIDE.
- (0.005) FER SIDE.

  5. DIMENSION D DOES NOT INCLUDE

  DAMBAR PROTRUSION. ALLOWABLE

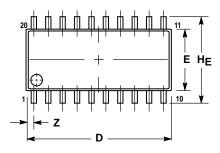
  DAMBAR PROTRUSION SHALL BE 0.13

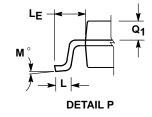
  (0.005) TOTAL IN EXCESS OF D DIMENSION AT MAXIMUM MATERIAL CONDITION.

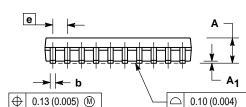
	MILLIMETERS		INC	HES
DIM	MIN	MAX	MIN	MAX
Α	12.65	12.95	0.499	0.510
В	7.40	7.60	0.292	0.299
С	2.35	2.65	0.093	0.104
D	0.35	0.49	0.014	0.019
F	0.50	0.90	0.020	0.035
G	1.27	BSC	0.050	BSC
J	0.25	0.32	0.010	0.012
K	0.10	0.25	0.004	0.009
M	0°	7°	0°	7°
Р	10.05	10.55	0.395	0.415
R	0.25	0.75	0.010	0.029

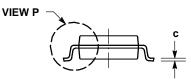
#### **M SUFFIX**

PLASTIC SOIC EIAJ PACKAGE CASE 967-01 ISSUE O









#### NOTES:

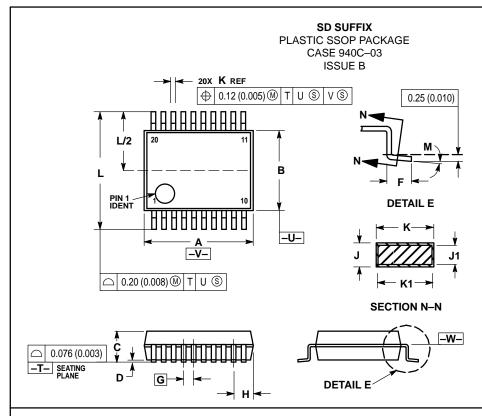
- 1 DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- Y14.5M, 1982.

  2 CONTROLLING DIMENSION: MILLIMETER.

  3 DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS AND ARE MEASURED AT THE PARTING LINE. MOLD FLASH OR PROTRUSIONS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
- PER SIDE.
  TERMINAL NUMBERS ARE SHOWN FOR
  REFERENCE ONLY.
  THE LEAD WIDTH DIMENSION (b) DOES NOT
  INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 (0.003) DANIORAR FRO I RUSION SHALL BE 0.08 (0.003)
  TOTAL IN EXCESS OF THE LEAD WIDTH
  DIMENSION AT MAXIMUM MATERIAL CONDITION.
  DAMBAR CANNOT BE LOCATED ON THE LOWER
  RADIUS OR THE FOOT. MINIMUM SPACE
  BETWEEN PROTRUSIONS AND ADJACENT LEAD
  TO BE 0.46 (0.018).

	MILLIMETERS		INC	HES
DIM	MIN	MAX	MIN	MAX
Α		2.05		0.081
Α <sub>1</sub>	0.05	0.20	0.002	0.008
b	0.35	0.50	0.014	0.020
С	0.18	0.27	0.007	0.011
D	12.35	12.80	0.486	0.504
E	5.10	5.45	0.201	0.215
е	1.27	BSC	0.050	BSC
HE	7.40	8.20	0.291	0.323
L	0.50	0.85	0.020	0.033
LE	1.10	1.50	0.043	0.059
M	0 °	10 °	0 °	10°
Q <sub>1</sub>	0.70	0.90	0.028	0.035
Z		0.81		0.032

### **OUTLINE DIMENSIONS**



- NOTES:
  13 DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.

  14 CONTROLLING DIMENSION: MILLIMETER.
- 14 CONTROCLING DIMENSION, MILLIUMETER.
  15 DIMENSION A DOES NOT INCLUDE MOLD FLASH,
  PROTRUSIONS OR GATE BURRS. MOLD FLASH
  OR GATE BURRS SHALL NOT EXCEED 0.15
- (0.006) PER SIDE.

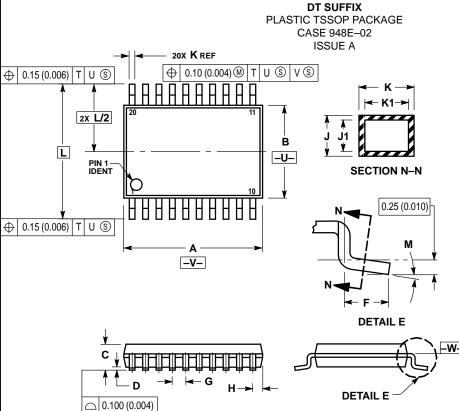
  16 DIMENSION B DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION. INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 0.15 (0.006) PER SIDE.

  17 DIMENSION K DOES NOT INCLUDE DAMBAR
- PROTRUSION/INTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.13 (0.005) TOTAL IN EXCESS OF K DIMENSION AT MAXIMUM MATERIAL CONDITION DAMBAR INTRUSION SHALL NOT REDUCE DIMENSION K BY MORE THAN 0.07 (0.002) AT LEAST MATERIAL
  CONDITION.

  18 TERMINAL NUMBERS ARE SHOWN FOR
  REFERENCE ONLY.

  19 DIMENSION A AND B ARE TO BE DETERMINED
  AT DATUM PLANE—W—.

	MILLIMETERS		INCHES	
DIM	MIN	MAX	MIN	MAX
Α	7.07	7.33	0.278	0.288
В	5.20	5.38	0.205	0.212
C	1.73	1.99	0.068	0.078
D	0.05	0.21	0.002	0.008
F	0.63	0.95	0.024	0.037
G	0.65 BSC		0.026 BSC	
Н	0.59	0.75	0.023	0.030
۲	0.09	0.20	0.003	0.008
J1	0.09	0.16	0.003	0.006
K	0.25	0.38	0.010	0.015
K1	0.25	0.33	0.010	0.013
Ĺ	7.65	7.90	0.301	0.311
М	0 °	8°	0 °	8 °



-T- SEATING PLANE

- 6 DIMENSIONING AND TOLERANCING PER ANSI
- 714.5M, 1982.
  7 CONTROLLING DIMENSION: MILLIMETER.
  8 DIMENSION A DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS. MOLD FLASH OR GATE BURRS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
- DIMENSION B DOES NOT INCLUDE INTERLEAD
   FLASH OR PROTRUSION. INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 0.25 (0.010) PER SIDE.
- 10 DIMENSION K DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 (0.003) TOTAL IN EXCESS OF THE K DIMENSION AT MAXIMUM MATERIAL CONDITION.

  11 TERMINAL NUMBERS ARE SHOWN FOR
- REFERENCE ONLY.

  12 DIMENSION A AND B ARE TO BE DETERMINED
- AT DATUM PLANE -W-.

	MILLIMETERS		INCHES	
DIM	MIN	MAX	MIN	MAX
Α	6.40	6.60	0.252	0.260
В	4.30	4.50	0.169	0.177
С		1.20		0.047
D	0.05	0.15	0.002	0.006
F	0.50	0.75	0.020	0.030
G	0.65 BSC		0.026 BSC	
Н	0.27	0.37	0.011	0.015
J	0.09	0.20	0.004	0.008
J1	0.09	0.16	0.004	0.006
K	0.19	0.30	0.007	0.012
<b>K</b> 1	0.19	0.25	0.007	0.010
Г	6.40 BSC		0.252 BSC	
М	0°	8°	0°	8°

#### MC74LCX373

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